

Day : Thursday

Date: 3/20/2003

Time: 18:04:44

PALM INTRANET**Inventor Name Search Result**

Your Search was:

Last Name = VISWANATHAN

First Name = LAKSHMINARAYAN

Application#	Patent#	Status	Date Filed	Title	Inventor Name
<u>06615662</u>	Not Issued	166	05/30/1984	ZIRCONIUM OXIDE-ION CONDUCTIVE ALKALI METAL ALUMINATE CERAMIC ARTICLES	VISWANATHAN , LAKSHMINARAYAN
<u>06705407</u>	Not Issued	166	02/25/1985	ZIRCONIUM OXIDE-ION CONDUCTIVE ALKALI METAL ALUMINATE CERAMIC ARTICLES	VISWANATHAN , LAKSHMINARAYAN
<u>09285827</u>	<u>6261868</u>	150	04/02/1999	SEMICONDUCTOR COMPONENT AND METHOD FOR MANUFACTURING THE SEMICONDUCTOR COMPONENT	VISWANATHAN , LAKSHMINARAYAN
<u>06341191</u>	Not Issued	166	01/20/1982	ZIRCONIUM OXIDE-ION CONDUCTIVE ALKALI METAL ALUMINATE CERAMIC ARTICLES	VISWANATHAN , LAKSHMINARAYAN
<u>07678764</u>	Not Issued	161	04/01/1991	DIFFUSION APPARATUS	VISWANATHAN , LAKSHMINARAYAN
<u>07459050</u>	Not Issued	161	12/29/1989	DIFFUSION APPARATUS	VISWANATHAN , LAKSHMINARAYAN
<u>09128022</u>	<u>6072211</u>	150	08/03/1998	SEMICONDUCTOR PACKAGE	VISWANATHAN , LAKSHMINARAYAN
<u>06788093</u>	Not Issued	166	10/15/1985	ZIRCONIUM OXIDE-ION CONDUCTIVE ALKALI METAL ALUMINATE CERAMIC ARTICLES	VISWANATHAN , LAKSHMINARAYAN
<u>07043222</u>	Not Issued	161	04/27/1987	ELECTRICAL CIRCUIT SUBSTRATE	VISWANATHAN , LAKSHMINARAYAN

				MATERIAL AND METHOD OF MAKING SAME	
<u>09287282</u>	<u>6072238</u>	150	04/07/1999	SEMICONDUCTOR COMPONENT	VISWANATHAN , LAKSHMINARAYAN
<u>10039800</u>	Not Issued	030	01/04/2002	WIRE BOND-LESS ELECTRONIC COMPONENT FOR USE WITH AN EXTERNAL CIRCUIT AND METHOD OF MANUFACTURE	VISWANATHAN, LAKSHMINARAYAN

Inventor Search Completed: No Records to Display.

**Search Another:
Inventor**

Last Name

VISWANATHAN

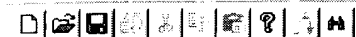
First Name

LAKSHMINARAYAN

Search

To go back use Back button on your browser toolbar.

Back to [PALM](#) | [ASSIGNMENT](#) | [OASIS](#) | [Home page](#)



- ☐ Drafts
- ☐ Pending
- ☒ Active
 - L1: (8) wire adj bond-less
- ☐ Failed
- ☐ Saved
- ☐ Favorites
- ☐ Tagged (0)

DBs: USPAT, EPO, JPO

☒ Plurals

Default operator: OR

☒ Highlight all hit terms initial

wire adj bond-less or wire adj bond adj less or wire adj
bondless

	U	I	Document ID	Issue Date	Pages	Title	Current OR	Current XRef
1	<input type="checkbox"/>	<input type="checkbox"/>	US 6358629 B1	20020319	8	Epoxy resin composition and semiconductor device using	428/620	257/789; 257/791;
2	<input type="checkbox"/>	<input type="checkbox"/>	US 6137138 A	20001024	7	MOSFET power transistor having offset gate and drain	257/341	257/343; 257/401;
3	<input type="checkbox"/>	<input type="checkbox"/>	US 5829663 A	19981103	7	Self locking key for ultrasonic transducers	228/1.1	228/904
4	<input type="checkbox"/>	<input type="checkbox"/>	US 5558270 A	19960924	7	Fine pitch capillary/wedge bonding tool	228/180.5	228/4.5
5	<input type="checkbox"/>	<input type="checkbox"/>	US 5343074 A	19940830	14	Semiconductor device having voltage distribution ring(s)	257/668	257/666; 257/E23.032;
6	<input type="checkbox"/>	<input type="checkbox"/>	US 5241456 A	19930831	17	Compact high density interconnect structure	361/792	174/250; 174/260;
7	<input type="checkbox"/>	<input type="checkbox"/>	US 4415115 A	19831115	12	Bonding means and method	228/170	228/180.5; 228/4.5
8	<input type="checkbox"/>	<input type="checkbox"/>	JP 10012928 A	19980116	6	WIRE BONDLESS SURFACE MOUNTED LED ELEMENT		